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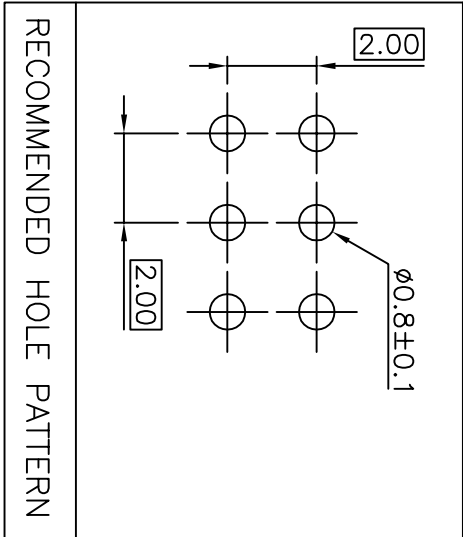
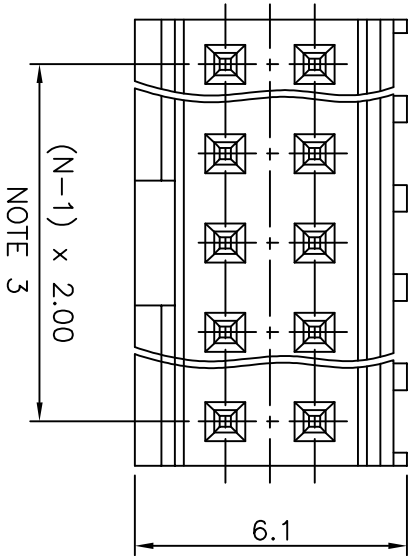
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PRODUCT NUMBER
90309-XXXXLF

PLATING

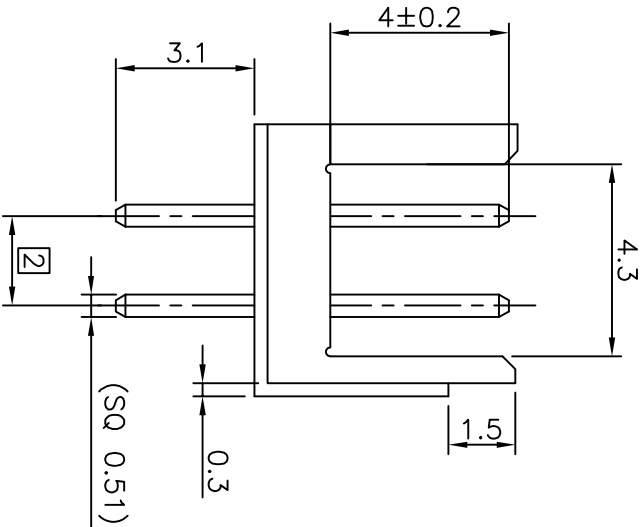
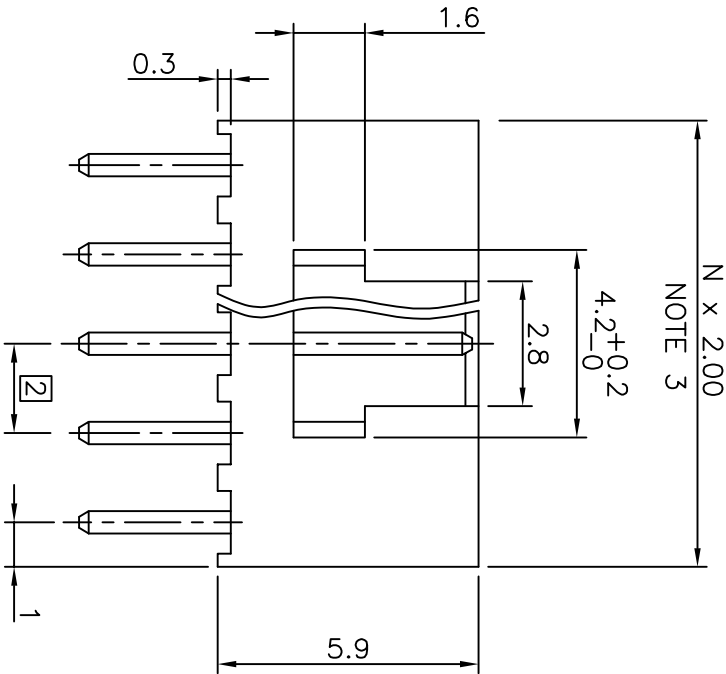
- 0 = 0.20µm GOLD/GXT ON CONTACT AREA
2µm MIN MATTE TIN ON TAIL
- 1 = 0.76µm GOLD/GXT ON CONTACT AREA
2µm MIN MATTE TIN ON TAIL
- 3 = 0.38µm GOLD/GXT ON CONTACT AREA
2µm MIN MATTE TIN ON TAIL
- 5 = 0.38µm GXT FULL PLATED
- 6 = 0.76µm GXT FULL PLATED
- 7 = 0.76µm GOLD/GXT FULL PLATED
- 9 = 0.20µm GOLD/GXT FULL PLATED
- 1.27µm Ni MIN DERPLATING

RoHS COMPATIBLE, SEE NOTE 6
PACKAGING, SEE NOTE 5
TOTAL NB OF POSITIONS, 08 TO 34



NOTES:

1. MATERIAL HOUSING: HIGH TEMP. THERMOPLASTIC
UL 94V-0, COLOR CREAM
2. MATERIAL TERMINAL: COPPER ALLOY
3. TO DETERMINE DIMENSIONS:
N = NUMBER OF POSITIONS PER ROW
4. 7N MIN. PIN RETENTION IN EITHER DIRECTION.
5. PACKAGING: T = POLYBAGS
T = TUBE
6. RoHS COMPATIBLE PRODUCT SPECIFICATIONS
- a - PLATING:
 - "LF" MEANS THE PRODUCT IS LEAD-FREE, 2µm MINIMUM MATTE TIN OVER 1.27µm MINIMUM NICKEL UNDERPLATE.
- b - MANUFACTURING PROCESS COMPATIBILITY
 - THE HOUSING WILL WITHSTAND EXPOSURE TO 260°C ±5°C SOLDER BATH TEMPERATURE FOR 5 SECONDS IN A WAVE SOLDER APPLICATION WITH A 1.6mm MIN THICK CIRCUIT BOARD.
- c - LABELLING:
 - MEETS PACKAGING SPECS AS PER GS-14-920
 - d - THIS PRODUCT MEETS EUROPEAN DIRECTIVES AND OTHER COUNTRY REGULATIONS AS DISCRIBED IN GS-47-0004.



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mat'l. code				surface		tolerance		projection		product family	
SEE NOTES				ISO 1302	ISO 406	ISO 101	ISO 101	mm	mm	MINITEK HEADER	
ltr	ecr	no	dr	date	tolerances unless otherwise specified						title
S	F05-0128	LMU	05.02.21								SHR HEADER
T	F06-0210	LMU	06.07.04	angles	linear	.XX	±0.13				2.00mm TMT DR
U	F07-0191	JCO	07.09.05	±2°		.XXX	±0.05				
V	F08-0145	ELA	15.04.08	dr	JL.CORDIER	97.07.26					dwg no
W	B-19190	LMU	14.10.24	eng	JL.COMPAGNON	97.07.26					sheet 1 of 1
				chr	JL.CORDIER	97.07.26					size
				appd	JMC	97.07.26					A3
sheet index	revision	sheet									